

"T300" Series, ECL High Reliability Hybrid Microcircuit Crystal Oscillators

Features

- Ruggedized Crystal Mount
- Radiation Tolerant to 10K Rads
- 100% Screening Options
- Low Phase Noise
- Hermetically Sealed Metal Package
- ECCN: EAR99

Applications

- High Shock & Vibration Applications
- Navigation Systems
- Aerospace Instrumentation
- Benign Space Applications
- Gun Launched Munitions

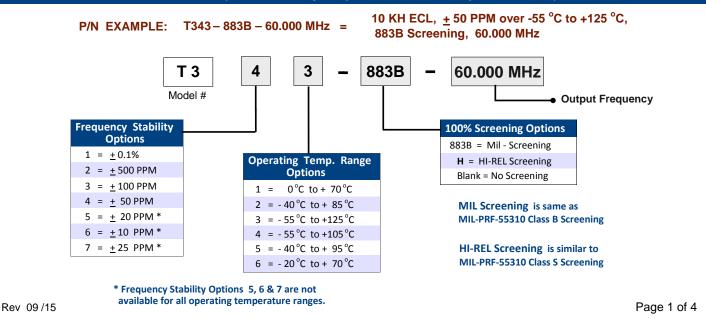
Package Specifications & Outline:

- Header & Leads Material: Kovar
- Cover Material: Nickel
- Seal: Hermetic Resistance Welded
- Weight: 4.0 Gms typical, 5.0 Gms Max.
- Thermal Resistance, Junction to Case (θ_{JC}): 22 $^{\circ}C$ / Watt
- Lead Soldering, Temp./Time: 260 °C, 10 Secs. Max.
- Header Finish: 100 to 250 μ inches nickel
- Lead Finish: 50 to 80 μ inches gold over 100 to 250 μ inches nickel

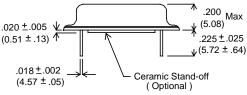
Hot Solder Tinning per MIL-PRF-55310 is optional at additional cost.

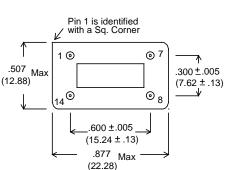
Contact Xsis Electronics at xsis@xsis.com for any special requirements.

ORDERING INFORMATION (Please build your part number from options below):

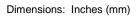


Xsis Electronics, Inc., 12620 W. 63rd St., Shawnee, KS 66216 Tel. 913-631-0448 Fax. 913-631-1170, www.xsis.com, email xsis@xsis.com





PIN #	FUNCTION
14	GND/CASE
7	- 5.2 VDC
8	OUTPUT
1	N/C





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Electrical Specifications:

Parameter	Specification Limits				
Output Frequency Range	10 MHz - 220 MHz				
Frequency Accuracy at +25 °C	<u>+</u> 15 PPM				
Frequency Stability Vs Temperature	See Ordering Information on Page 1				
Operating Temperature Range	See Ordering Information on Page 1				
Supply Voltage (Vdd)	- 5.2 VDC <u>+</u> 10%				
Input Current (no Load)	50 mA Max				
Output Waveform	Square Wave, ECL 10K & 10 KH Compatible				
Output Duty Cycle (at 50% Output Level)	60/40% Max.				
Output High Level	10K & 10 KH Compatible				
Output Low Level	10K & 10 KH Compatible				
Output Load	100 Ω to - 2.0 VDC				
Rise & Fall Times (Typical Load)	2 nS Max.				
Start-Up Time	10 mS Max.				
Phase Jitter (10 KHz - 20 MHz Integrated)	0.10 pS rms Typical				
Freq. Stability Vs Supply Voltage <u>+</u> 4 PPM Max. for <u>+</u> 10% change in Supply Voltage					
Aging at 70 °C	\pm 3 PPM Max. first year, \pm 2 PPM Max. per year thereafter				
Absolute Maximum Applied Voltage	+ 7 VDC				
Storage Temperature	-65 °C to +125 °C				

NOTE: For PECL applications, Xsis 300 Series oscillators can be operated with +5 VDC <u>+</u> 10% on Pin 14 and power supply return on Pin 7. Output signal can be AC or DC coupled.

For special requirements, such as, tighter output symmetry, faster start-up time, PIND screening, etc., please contact Xsis Electronics at xsis@xsis.com or call us at 913-631-0448.

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Packaging: ESD protective conductive foam tray.

Thermal Characteristics:

Junction to case Thermal Constant (θ_{JC}): 22 °C / Watt Junction to Ambient (Device floating in free air) Thermal Constant (θ_{JA}): 85 °C / Watt

Hi-Rel Screening:

When HI-REL option is selected, Xsis Oscillators are subjected to 100% screening similar to Class "S" screening in accordance with MIL-PRF-55310. Refer to <u>www.xsis.com</u> for additional details about HI-REL screening.

Typical Phase Noise (dbc/Hz):

Output Frequency	10 Hz	100 Hz	1 KHz	10 KHz	100 KHz	1 MHz
10 MHz	-109	-140	-157	-162	-163	-164
25 MHz	-100	-127	-151	-158	-160	-162
50 MHz	-89	-117	-148	-157	-159	-160
96 MHz	-80	-107	-139	-151	-156	-158
100 MHz	-77	-104	-133	-145	-151	-155

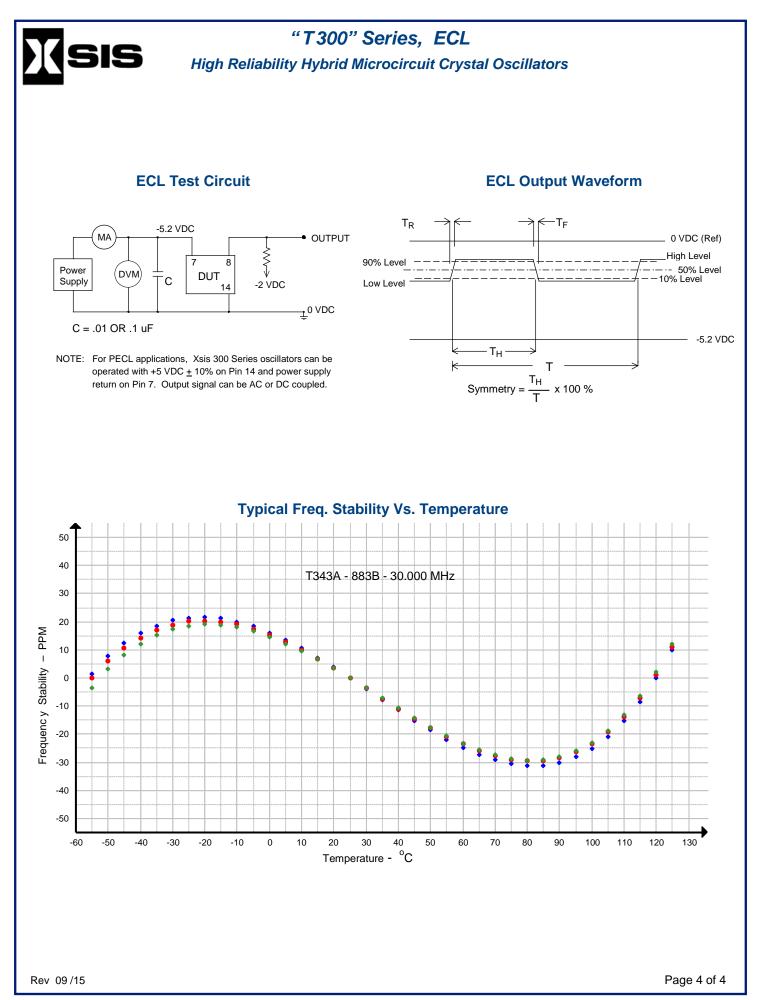
Environmental Specifications:

T300 series oscillators are designed to meet or exceed the Environmental tests specified below. Customized screening and environmental testing are also available to meet your special requirements.

Test	Test Conditions			
Vibration	0.06" DA, 30 G peak, 10 - 2000 Hz, MIL-STD-202, Method 204, Cond. G			
Shock	1500 G, 0.5 mS, half-Sine, MIL-STD-883, Method 2002, Cond. B			
Temperature Cycling	MIL-STD-883, Method 1010, Cond. C			
Thermal Shock	MIL-STD-202, Method 107, Cond. B			
Seal (Fine and Gross)	MIL-STD-883, Method 1014 Cond. A & C			
Burn-in	160 Hours, 125 °C, Nominal Supply Voltage & Load			
Frequency Aging	30 days at 70 °C, \pm 1.5 PPM Max.			
Altitude	MIL-STD-202, Method 105, Cond. C			
Constant Acceleration	MIL-STD-883, Method 2001, 5000 G			
Moisture Resistance	MIL-STD-202, Method 106, Vibration Sub Cycle Omitted			
Solderability	MIL-STD-202, Method 208			
Resistance to Soldering Heat	MIL-STD-202, Method 210, Cond B. or C as applicable			
Resistance to Solvents	MIL-STD-202, Method 215			
Internal Water Vapor Content	MIL-STD-883, Method 1018			
ESD Classification	MIL-STD-883, Method 3015, Class 1C, HBM 1000 to 1999			
Moisture Sensitivity Level	J-STD-020, MSL=1			

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